# i.MX RT1050 FEATURES AND BENEFITS

#### CROSSOVER PROCESSING

- Highest performing ARM<sup>®</sup> Cortex<sup>®</sup>-M7 core with real-time operation delivering 3015 CoreMark<sup>®</sup>/1284 DMIPS @ 600 MHz
  - More than 250% faster than existing Cortex-M4 products
- Real-time, low latency response with the largest tightly coupled memory (TCM) at 512KB
  - 20 nanosecond interrupt latency—shortest among all ARM Cortex products
- Low dynamic power consumption enabled by DC-DC converter and efficient power gating
  - Half the run mode power of other Cortex-M7 products—as low as 110 µA/MHz

# HIGH LEVEL OF INTEGRATION

- High security enabled by AES-128 cryptography, high assurance boot (HAB), TRNG and on-the-fly QSPI flash decryption
- Most comprehensive multimedia platform integrated with a Cortex-M core
  - 2-D graphics acceleration, parallel camera sensor I/F, LCD display controller up to WVGA, multichannel high-performance audio
- Connectivity peripherals enable wireless connectivity
  - Wi-Fi<sup>®</sup>, Bluetooth<sup>®</sup>, BLE, ZigBee<sup>®</sup>, Thread<sup>™</sup> and other options

# **EASY TO USE**

- Fast development with popular tools
  - MCUXpresso, IAR, ARM Keil<sup>®</sup>, FreeRTOS<sup>™</sup>, SDK, ARM mbed<sup>™</sup> and low cost EVK compatible with Arduino<sup>™</sup> hardware shields
- Single voltage input simplifies power circuit design
- Exceptional scalability and compatibility to thousands of Kinetis, LPC and i.MX products

# LOW BOM COST

- Highest performing ARM<sup>®</sup>
  Lowest-priced Cortex-M7
  solution in the market at
- Fully integrated PMIC with a DC-DC converter, eliminating need for external power supply
- Low cost 10x10 BGA package with .65mm pitch enabling 4 layer PCB design



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